

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	23408	core and (PWB PCB ((printed wiring circuit near board)) and ((via thru-hole through-hole (thru through) near hole) interconnect\$3)	US-PGPU B; USPAT	OR	ON	2005/09/27 16:17
S2	2690	S1 and (conducti\$2 filled) near (adhesi\$2 epoxy thermoset thermplastic) ablebond\$4 ablestik	US-PGPU B; USPAT	OR	ON	2005/09/27 16:20
S3	457	S1 and (CMP polish\$3 near2 chemical\$2)	US-PGPU B; USPAT	OR	ON	2005/09/27 16:21
S4	9796	S1 and (nub nib protr\$4 post bump)	US-PGPU B; USPAT	OR	ON	2005/09/27 16:22
S5	6187	S1 and etch\$3	US-PGPU B; USPAT	OR	ON	2005/09/27 16:22
S6	807	S1 and (FR4 glass near2 reinforced near2 epoxy)	US-PGPU B; USPAT	OR	ON	2005/09/27 16:23
S8	1233	S2 and S4	US-PGPU B; USPAT	OR	ON	2005/09/27 16:23
S9	1120	S2 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:23
S7	107	S2 and S3	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S10	237	S2 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S11	279	S3 and S4	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24

S12	353	S3 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S13	23	S3 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S15	406	S4 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S16	539	S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S17	89	S2 and S3 and S4	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S18	100	S2 and S3 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:24
S19	14	S2 and S3 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:25
S20	771	S2 and S4 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:25
S21	154	S2 and S4 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:25
S22	172	S2 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:26
S23	85	S2 and S3 and S4 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:26
S24	13	S2 and S3 and S4 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:26
S25	112	S2 and S4 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:27

S26	17	S3 and S4 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:28
S27	14	S2 and S3 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:28
S28	13	S2 and S3 and S4 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:31
S29	286	S4 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:32
S30	23	S3 and S5 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:32
S31	17	S3 and S4 and S6	US-PGPU B; USPAT	OR	ON	2005/09/27 16:32
S32	237	S3 and S4 and S5	US-PGPU B; USPAT	OR	ON	2005/09/27 16:32
S33	23	S13 S19 S24 S26 S27 S28 S30 S31	US-PGPU B; USPAT	OR	ON	2005/09/27 16:35

S34	77	("3011920" "3436819" "3541222" "3772056" "3772078" "3783005" "3791858" "3795047" "3846168" "3971610" "3993799" "4151313" "4249302" "4325983" "4358479" "4512829" "4554182" "4604799" "4775611" "4781788" "4783722" "4917758" "4931148" "4994139" "5092032" "5118385" "5135606" "5178914" "5200026" "5220135" "5271150" "5308796" "5322593" "5435480" "5457079" "5624268" "5670011" "5670425" "5672226" "5719354" "5759427" "5789320" "5819406" "5891513" "5920123" "5984691" "6009620" "6013876" "6015520" "6059579" "6125531" "6138350" "6168442" "6222136" "6291779" "6378201" "6388204" "6486394"). PN. OR ("2002/0150741" "2004/0126547" "5242540" "6264851" "6465084" "6645607" "6711813").URPN.	US-PGPU B; USPAT; USOCR	OR	OFF	2005/09/27 16:42
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S35	24	(US-6914200-\$ or US-6486394-\$ or US-6426011-\$ or US-6388204-\$ or US-6378201-\$ or US-6291779-\$ or US-6222136-\$ or US-6138350-\$ or US-6125531-\$ or US-6015520-\$ or US-6009620-\$ or US-5984691-\$ or US-5920123-\$ or US-5719354-\$ or US-5624268-\$ or US-5435480-\$ or US-5271150-\$ or US-5220135-\$ or US-5135606-\$ or US-4783722-\$ or US-4512829-\$ or US-4249302-\$ or US-3971610-\$ or US-3436819-\$).did.	USPAT	OR	OFF	2005/09/27 17:02
S36	0	S35 and multiple adj passes	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:07
S37	0	S35 and passes	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:07

S38	12	S35 and multiple	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:09
S39	1	S35 and residu\$3	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:11
S40	6	S1 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12
S41	3	S2 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12
S42	1	S3 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12

S43	2	S4 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12
S44	5	S5 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12
S45	2	S6 and S35	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12
S46	7	S40 S41 S42 S43 S44 S45	US-PGPU B; USPAT; EPO; JPO; DERWEN T; IBM_TDB	OR	OFF	2005/09/27 17:12

[illegible]

L13	23456	core and (PWB PCB ((printed wiring circuit near board)) and ((via thru-hole through-hole (thru through) near hole) interconnect\$3)	US-PGPU B; USPAT	OR	ON	2005/10/03 04:52
L14	203	12 and L13	US-PGPU B; USPAT	OR	ON	2005/10/03 04:52
L15	31	(US-20020150741-\$ or US-20040126547-\$).did. or (US-3436819-\$ or US-3971610-\$ or US-4249302-\$ or US-4512829-\$ or US-4783722-\$ or US-5135606-\$ or US-5220135-\$ or US-5242540-\$ or US-5271150-\$ or US-5435480-\$ or US-5624268-\$ or US-5719354-\$ or US-5920123-\$ or US-5984691-\$ or US-6009620-\$ or US-6015520-\$ or US-6125531-\$ or US-6138350-\$ or US-6222136-\$ or US-6264851-\$ or US-6291779-\$ or US-6378201-\$ or US-6388204-\$ or US-6426011-\$ or US-6465084-\$ or US-6486394-\$).did. or (US-6645607-\$ or US-6711813-\$ or US-6914200-\$).did.	US-PGPU B; USPAT	OR	ON	2005/10/03 04:53
L16	2	12 and 15	US-PGPU B; USPAT	OR	ON	2005/10/03 04:54

L17	9818	L13 and (nub nib protrude post bump)	US-PGPU B; USPAT	OR	ON	2005/10/03 04:57
L18	6207	L13 and etch\$3	US-PGPU B; USPAT	OR	ON	2005/10/03 04:57
L19	3231	L17 and L18	US-PGPU B; USPAT	OR	ON	2005/10/03 04:57
S14	3220	S4 and S5	US-PGPU B; USPAT	OR	ON	2005/10/03 04:57
L20	74	12 and L19	US-PGPU B; USPAT	OR	ON	2005/10/03 04:58

L21	77	("3011920" "3436819" "3541222" "3772056" "3772078" "3783005" "3791858" "3795047" "3846168" "3971610" "3993799" "4151313" "4249302" "4325983" "4358479" "4512829" "4554182" "4604799" "4775611" "4781788" "4783722" "4917758" "4931148" "4994139" "5092032" "5118385" "5135606" "5178914" "5200026" "5220135" "5271150" "5308796" "5322593" "5435480" "5457079" "5624268" "5670011" "5670425" "5672226" "5719354" "5759427" "5789320" "5819406" "5891513" "5920123" "5984691" "6009620" "6013876" "6015520" "6059579" "6125531" "6138350" "6168442" "6222136" "6291779" "6378201" "6388204" "6486394"). PN. OR ("2002/0150741" "2004/0126547" "5242540" "6264851" "6465084" "6645607" "6711813").URPN.	US-PGPU B; USPAT; USOCR	OR	OFF	2005/10/03 04:58
L22	0	12 and L21	US-PGPU B; USPAT	OR	ON	2005/10/03 04:59
L23	2697	L13 and (conducti\$2 filled) near (adhesi\$2 epoxy thermoset thermplastic) ablebond\$4 ablestik	US-PGPU B; USPAT	OR	ON	2005/10/03 04:59
L24	774	L23 and L17 and L18	US-PGPU B; USPAT	OR	ON	2005/10/03 04:59

L26	2	15 and 25	US-PGPU B; USPAT	OR	ON	2005/10/03 04:59
L25	16	12 and L24	US-PGPU B; USPAT	OR	ON	2005/10/03 05:00
L27	4	(US-6440641-\$ or US-6376052-\$ or US-5591353-\$ or US-5433822-\$).did.	USPAT	OR	ON	2005/10/03 05:09
L28	24	(US-6138350-\$ or US-6125531-\$ or US-6486394-\$ or US-6426011-\$ or US-5435480-\$ or US-5984691-\$ or US-5920123-\$ or US-5271150-\$ or US-5135606-\$ or US-5719354-\$ or US-5624268-\$ or US-3436819-\$ or US-5220135-\$ or US-4249302-\$ or US-3971610-\$ or US-4512829-\$ or US-6388204-\$ or US-6378201-\$ or US-6291779-\$ or US-6222136-\$ or US-6015520-\$ or US-6009620-\$ or US-6914200-\$ or US-4783722-\$).did.	USPAT	OR	ON	2005/10/03 05:10
L29	28	27 28	US-PGPU B; USPAT	OR	ON	2005/10/03 05:30
L30	14306	(fill\$3 core) with conductive near (polymer resin adhesive filled thermoset)	US-PGPU B; USPAT	OR	ON	2005/10/03 05:32
L31	14328	29 30	US-PGPU B; USPAT	OR	ON	2005/10/03 05:32

L32	6	29 and 30	US-PGPU B; USPAT	OR	ON	2005/10/03 05:32
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